ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declar the declaration	ration of n encon	of the substand npasses all lo	ces with wer lev	in the manufact el materials for	turer listed i which the n	tem. N nanufa	ote: if the	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and M	ials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Respon	Response Date*					
onsemi										2024-05-15					
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iten	n Number				Effective Da	ate V	ersion	n Manufacturing Site			Weigh	t*	UOM	Unit Type
	NC7SZ	19FHX				2024-05-15	2024-05-15 THB				1.395		mg	Each	
Aanufacturing Proccess Informa	ation		1			1								1	I
Terminal Plating / Grid Array M	faterial	Ferminal Base	Alloy J	J-STD-020 MSL Rating		Peak Process Bod		Body Tempera	y Temperature Max Time at Peak		ak Tempera	Temperature Number		of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		ids 3	3		
omments															
evel 1 - maximum time at peak temperat	ture during so	ldering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.111	mg	Supplier	Silicon (Si)	7440-21-3		0.111	mg
Die Attach Tape	0.014	mg	Supplier	Oxirane, (chloromethyl)-, homopolymer	24969-06-0		0.0021	mg
			Supplier	2-Propenoic acid, 2-methyl-, polymer with butyl 2-propenoate and methyl 2- methyl-2-propenoate	25035-69-2		0.0021	mg
			Supplier	Proprietary	Proprietary Data		0.0014	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0063	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0021	mg
Lead Frame	0.402	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0007	mg
			Supplier	Silicon (Si)	7440-21-3		0.0029	mg
			В	Nickel (Ni)	7440-02-0		0.013	mg
			Supplier	Copper (Cu)	7440-50-8		0.3854	mg
Mold Compound-Black	0.852	mg		Epoxy resin	proprietary data		0.0426	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0196	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0426	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0034	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0196	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.7242	mg
Plating	0.014	mg	Supplier	Palladium (Pd)	7440-05-3		0.001	mg
			В	Nickel (Ni)	7440-02-0		0.013	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
Wire Bond	0.002	mg	Supplier	Palladium (Pd)	7440-05-3		0	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.002	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).